



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant(s): Won Sun Shin et al.

Assignee: Amkor Technology, Inc.

Title: SEMICONDUCTOR PACKAGE AND METHOD FOR FABRICATING

THE SAME

Serial No.: 10/600,931

Filed: June 20, 2003

Examiner: Nguyen, Cuong Group Art 2811

Quang Unit:

Docket No.: GK001501

Monterey, CA April 28, 2005

Mail Stop Amendment Commissioner for Patents P.O. Box 1450 Alexandria, VA 22313-1450

UNDER §1.97(b)

Sir:

Pursuant to 37 C.F.R. §§ 1.56, 1.97 and 1.98, Applicant(s) wish to call the following documents (a copy of each is enclosed) to the attention of the Examiner.

U.S. PATENT DOCUMENTS

	DOCUMENT NUMBER	DATE	NAME
1)	3,851,221	11/26/74	Beaulieu et al.
2)	4,567,643	02/04/86	Droguet et al.
3)	4,730,232	03/08/88	Lindberg
4)	4,982,265	01/01/91	Watanabe et al.
5)	4,996,587	02/26/91	Hinrichsmeyer et al.
6)	5,040,052	08/13/91	McDavid
7)	5,138,438	08/11/92	Masayuki et al.
8)	5,140,404	08/18/92	Fogal et al.
9)	5,165,067	11/17/92	Wakefield et al.
10)	5,198,888	03/30/93	Sugano et al.

11)	5,229,647	07/20/93	Gnadinger
12)	5,334,875	08/02/94	Sugano et al.
13)	5,426,563	06/20/95	Moresco et al.
14)	5,432,729	07/11/95	Carson et al.
15)	5,473,196	12/05/95	De Givry
16)	5,495,394	02/27/96	Kornfeld et al.
17)	5,514,907	05/07/96	Moshayedi
18)	5,569,625	10/29/96	Yoneda et al.
19)	5,581,498	12/03/96	Ludwig et al.
20)	5,587,341	12/24/96	Masayuki et al.
21)	5,614,766	03/25/97	Takasu et al.
22)	5,637,536	06/10/97	Val
23)	5,637,912	06/10/97	Cockerill et al.
24)	5,682,062	10/28/97	Gaul
25)	5,783,870	07/21/98	Mostafazadeh et al.
26)	5,798,014	08/25/98	Weber
27)	5,861,666	01/19/99	Bellaar
28)	5,872,025	02/16/99	Cronin et al.
29)	5,885,849	03/23/99	DiStefano et al.
30)	5,917,242	06/29/99	Ball
31)	6,180,881	01/30/01	Isaak
32)	6,235,554	05/22/01	Akram et al.
33)	6,452,278	09/17/02	DiCaprio et al.
34)	6,576,998	06/10/03	Hoffman

FOREIGN DOCUMENTS

	DOCUMENT NUMBER	DATE	COUNTRY
1)	JP4368154	12/21/92	Japan
2)	JP4368167	12/21/92	Japan
3)	JP5283601	10/29/93	Japan
4)	JP54128274	04/10/79	Japan
5)	JP61059862	03/27/86	Japan
6)	JP62119952	06/01/87	Japan
7)	JP62142341	06/25/87	Japan

8)	JP63211663	09/02/88	Japan
9)	KR1019990016319	05/07/99	Rep. Of Korea
10)	KR1019990020939	06/07/99	Rep. Of Korea
11)	KR1019990037925	09/07/99	Rep. Of Korea
12)	KR1019990037928	09/07/99	Rep. Of Korea

OTHER DOCUMENTS

1)	Smith et al., U.S. Patent Application Serial No. 09/944,732,
	filed August 31, 2001, entitled "THIN SEMICONDUCTOR PACKAGE
	INCLUDING STACKED DIES"

A PTO form 1449 listing these documents is enclosed.

The relevance of the non-English language documents is set forth in the enclosed English translations of the abstracts.

Citation of the above documents shall not be construed as:

- 1. an admission that the documents are necessarily prior art with respect to the instant invention;
- 2. a representation that a search has been made, other than as described above; or
- 3. an admission that the information cited herein is, or is considered to be, material to patentability as defined in § 1.56(b).

If a petition is required for consideration of this Information Disclosure Statement, Applicants hereby so petition.

The Commissioner is hereby authorized to charge any fees required for consideration of this Information Disclosure

Statement, and to credit any overpayment of fees to Deposit Account No. 50-0553.

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being deposited with the United States Postal Service with sufficient postage as first class mail in an envelope addressed to: Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450, on April 28, 2005.

Attorney for Applicant(s)

April 28, 2005

Date of Signature

Respectfully submitted,

Serge J. Hodgson

Attorney (for Applicant(s)

Reg. No. 40,017/ (831) 655-0880 FORM PTO-1449

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IMPORMATION DISCLOSURE CITATION

IN AN APPLICATION

(Use several sheets if necessary)

Atty Docket No. Serial No.

GK001501 10/600,931

Applicant(s)
Won Sun Shin et al.

Filing Date
June 20, 2003

Group 2811

U.S. PATENT DOCUMENTS

EXAMINER INITIAL			DATE	NAME	CLASS	SUBCLASS	FILING DATE IF APPROPRIATE
	AA	3,851,221	11/26/74	Beaulieu et al.	317	100	
	AB	4,567,643	02/04/86	Droguet et al.	29	575	
	AC	4,730,232	03/08/88	Lindberg	361	381	
	AD	4,982,265	01/01/91	Watanabe et al.	357	75	
	AE	4,996,587	02/26/91	Hinrichsmeyer et al.	357	74	
	AF	5,040,052	08/13/91	McDavid	357	80	
	AG	5,138,438	08/11/92	Masayuki et al.	357	75	
	AH	5,140,404	08/18/92	Fogal et al.	357	70	
	AI	5,165,067	11/17/92	Wakefield et al.	257	783	
	AJ	5,198,888	03/30/93	Sugano et al.	257	686	
	AK	5,229,647	07/20/93	Gnadinger	257	785	

FOREIGN PATENT DOCUMENTS

						Trans	lation
	DOCUMENT NUMBER	DATE	COUNTRY	CLASS	SUBCLASS	YES	мо
AL	JP4368154	12/21/92	Japan			Abst	
AM	JP4368167	12/21/92	Japan			Abst	
AN	JP5283601	10/29/93	Japan			Abst	
AO	JP54128274	04/10/79	Japan			Abst	
AP	JP61059862	03/27/86	Japan			Abst	

OTHER DOCUMENTS (Including Author, Title, Date, Pertinent Pages, Etc.)

AR	Smith et al., U.S. Patent Application Serial No. 09/944,732, filed August 31, 2001, entitled "THIN SEMICONDUCTOR PACKAGE INCLUDING STACKED DIES"
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Examiner

Date Considered

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant(s).

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	AA	5,334,875	08/02/94 Suga			Э 6	et al.	257	686				
	AB	5,426,563	06	/20/95	Moreso	co	et al.	361	689				
	AC	5,432,729	07	//11/95	Carson	n e	et al.	365	63		, , <u>, , , , , , , , , , , , , , , , , </u>		
	AD	5,473,196	12	/05/95	De Giv	лry	7	257	786				
	AE	5,495,394	02	/27/96	Kornfe	eld	l et al.	361	764				
	AF	5,514,907	05	/07/96	Moshay	/ec	li	257	723				
	AG	5,569,625	10	/29/96	Yoneda	a e	et al.	437	217				
	AH 5,581,498 12/03/96 L				Ludwig	g e	et al.	365	63				
	AI	5,587,341	12	24/96	Masayuki et al.		437	206					
	АJ	5,614,766	03	/25/97	Takasu et al.		257	777					
	AK	5,637,536	06/10/97		Val		438	686					
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	AO	KR10199900163	19	05/07/9	99 Rep	. .	Of Korea				Abst		
	AP	KR10199900209	39	06/07/	99 Rep	9 Rep. Of Korea					Abst		
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	AA	5,637,912	06/10/97 Cocker:			ril	l et al.	257	620				
	AB	5,682,062	10/2	28/97	Gaul			257	686				
	AC	5,783,870	07/2	21/98	Mosta	faz	adeh et al.	257	791				
	AD	5,798,014	08/2	25/98	Weber			156	263				
	AE	5,861,666	01/	19/99	Bella	ar	<u>. </u>	257	686				
	AF	5,872,025	02/	16/99	Croni	n e	t al.	438	109				
	AG 5,885,849 03/23/99			DiSte	fan	o et al.	438	108			_		
	AH	5,917,242	06/2	29/99	Ball			257	737				
	ΑI	6,180,881	01/3	30/01	Isaak			174	52.4				
	АJ	6,235,554	05/2	22/01	Akram et al.		438	109					
	AK	6,452,278	09/:	09/17/02 Di		DiCaprio et al.		257	257 777				
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EXAMINER INITIAL		DOCUMENT NUMBER DATE NAME						CLASS	SUBCLAS	s	FILING DATE IF APPROPRIATE		
	AA	6,576,998	06/1	0/03	Hoff	man		257	724				
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	AC												
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